

Features

- 0603 0.4mm SMD LED
- High Brightness
- AlInGaP / InGaN Technology
- Small package
- High reliability
- Clear Lens

Applications

- Consumer Electronics
- Wearables
- Automobile After Market
- Industrial Equipment

Description

The IN-S63AT series is a popular low profile 0603 package with versatile design capabilities. It is a PCB type molding style LED which can be used in various applications.

Recommended Solder Pattern

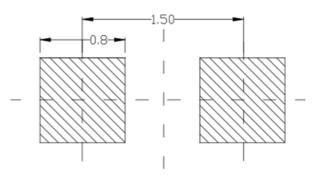
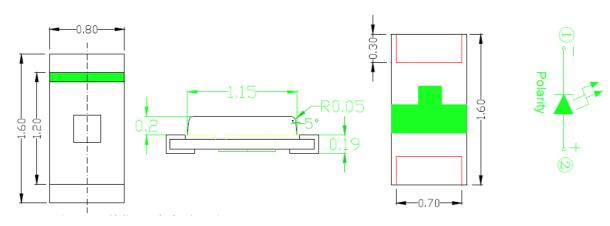


Figure 1. IN-S63AT Solder Pattern



Package Dimensions in mm

Notes.

- 1. All dimensions are in millimeters.
- 2. Tolerance is ± 0.10 mm unless otherwise noted

Figure 2. IN-S63AT Package Dimensions



Absolute Maximum Rating at 25°C (Note 1)

Product	Emission Color	P _d (mW)	I _F (mA)	I _{FP} * (mA)	V _R (V)	T _{OP} (°C)	T _{st} (°C)
IN-S63AT5YG	Yellow Green						
IN-S63AT5Y	Yellow	75	25	70		-40°C~+85°C	
IN-S63AT5A	Amber	75	23	10			
IN-S63ATR	Red				5		-40°C~+90°C
IN-S63AT5B	Blue						
IN-S63AT5G	Green	75	25	100			
IN-S63AT5UW	White						

Notes

1. Condition for IFP is pulse of 1/10 duty and 0.1msec width

ESD Precaution

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly. If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).



Electrical Characteristics $T_A = 25$ °C (Note 1)

	Emission		V _F (V)	λ(nm)			Viewing Angel	l [*] ∨(mcd)
Product	Color	I⊧(mA)	typ.	λ_{D}	λ _P	Δλ	2 01/2	typ.
IN-S63AT5YG	Yellow Green	5	2.0	573	574	15	120	11.5
IN-S63AT5Y	Yellow	5	2.0	589	593	30	120	35
IN-S63AT5A	Amber	5	2.0	605	609	30	120	35
IN-S63ATR	Red	20	2.2	622	636	30	120	120
IN-S63AT5B	Blue	5	2.8	470	468	30	120	45
IN-S63AT5G	Green	5	2.7	525	530	35	120	285
IN-S63AT5UW	White	5	2.8	X=0.29 Y=0.29	-	-	120	285

Notes

1. Performance guaranteed only under conditions listed in above tables.



IN-S63AT series Top View SMD LED 0603 PCB Type

Chromaticity Bin (for White only)

Bin Code	CIE-X	CIE-Y									
	0.27	0.291		0.26	0.271		0.25	0.251		0.24	0.231
Z4	0.28	0.311	Z3	0.27	0.291	Z2	0.26	0.271	Z1	0.25	0.251
21	0.283	0.305	20	0.2735	0.286		0.264	0.267		0.2545	0.248
	0.2735	0.286		0.264	0.267		0.2545	0.248		0.245	0.2291
	0.2735	0.2860		0.2640	0.2670		0.2545	0.2480		0.2497	0.2267
B5	0.2772	0.2800	B1	0.2680	0.2623	A5	0.2589	0.2445	A1	0.2450	0.2290
20	0.2863	0.2978		0.2772	0.2800	110	0.2680	0.2623		0.2545	0.2480
	0.2830	0.3050		0.2735	0.2860		0.2640	0.2670		0.2589	0.2445
	0.2772	0.2800		0.2720	0.2575		0.2589	0.2445		0.2497	0.2267
B6	0.2808	0.2740	B2	0.2680	0.2623	A6	0.2633	0.2410	A2	0.2589	0.2445
20	0.2895	0.2905		0.2772	0.2800	110	0.2720	0.2575	12	0.2633	0.2410
	0.2863	0.2978		0.2808	0.2740		0.2680	0.2623		0.2545	0.2245
	0.2808	0.2740		0.2720	0.2575		0.2677	0.2375		0.2593	0.2223
В7	0.2844	0.2680	B3	0.2760	0.2528	A7	0.2633	0.2410	A3	0.2677	0.2375
	0.2928	0.2833	20	0.2844	0.2680		0.2720	0.2575	110	0.2633	0.2410
	0.2895	0.2905		0.2808	0.2740		0.2760	0.2528		0.2545	0.2245
	0.2844	0.2680		0.2760	0.2528		0.2720	0.2340		0.2640	0.2200
B8	0.2928	0.2833	B4	0.2844	0.2680	A8	0.2677	0.2375	Α4	0.2593	0.2223
	0.2960	0.2760		0.2880	0.2620	110	0.2760	0.2528		0.2677	0.2375
	0.2880	0.2620		0.2800	0.2480		0.2800	0.2480		0.2720	0.2340
	0.2300	0.2110		0.22	0.191		0.2800	0.3110		0.2883	0.3172
AF	0.2355	0.2102	AA	0.226	0.1913	Z5	0.2871	0.3210	C5	0.2870	0.3210
	0.2450	0.2291		0.2355	0.2102		0.2895	0.3134		0.2937	0.3312
	0.2400	0.2310		0.23	0.211		0.2830	0.3050		0.2950	0.3266
	0.2355	0.2102		0.226	0.1913		0.2830	0.3050		0.2883	0.3172
AG	0.2405	0.2089	AB	0.2313	0.1911	C1	0.2863	0.2978	C6	0.2950	0.3266
	0.2497	0.2267		0.2405	0.2089		0.2923	0.3052		0.2962	0.3220
	0.2450	0.2291		0.2355	0.2102		0.2895	0.3134		0.2895	0.3134
	0.2405	0.2089		0.2313	0.1911		0.2863	0.2978		0.2895	0.3134
AH	0.2457	0.2080	AC	0.2369	0.1915	C2	0.2895	0.2905	C7	0.2908	0.3097
	0.2545	0.2245		0.2457	0.208	02	0.2950	0.2970		0.2973	0.3177
	0.2497	0.2267		0.2405	0.2089		0.2923	0.3052		0.2962	0.3220
	0.2457	0.2080		0.2369	0.1915		0.2895	0.2905		0.2908	0.3097
AI	0.2509	0.2071	AD	0.2425	0.1919	C3	0.2928	0.2833	C8	0.2920	0.3060
	0.2593	0.2223		0.2509	0.2071		0.2977	0.2891		0.2984	0.3133
	0.2545	0.2245		0.2457	0.208		0.2950	0.2970		0.2973	0.3177
	0.2509	0.2071		0.2425	0.1919		0.2928	0.2833		0.2920	0.3060
AJ	0.2560	0.2060	AE	0.2480	0.1920	C4	0.2977	0.2891	D1	0.2935	0.3015
	0.2640	0.2200		0.2560	0.2060		0.3003	0.2812		0.2997	0.3088
	0.2593	0.2223		0.2509	0.2071		0.2960	0.2760		0.2984	0.3133
	0.2935	0.3015		0.2950	0.2970		0.2965	0.2925		0.2937	0.3312
D2	0.2950	0.2970	D3	0.2965	0.2925	D4	0.2980	0.2880	D5	0.2950	0.3266
02	0.3009	0.3042	03	0.3023	0.2990	1/1	0.3037	0.2937	00	0.3017	0.3360
	0.2997	0.3088		0.3009	0.3042		0.3023	0.2990		0.3005	0.3415



7600K

CI

C6

C8

D1

D2

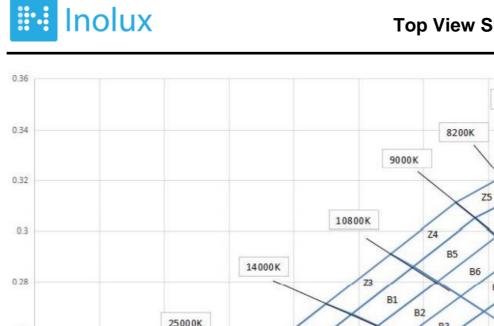
7000K

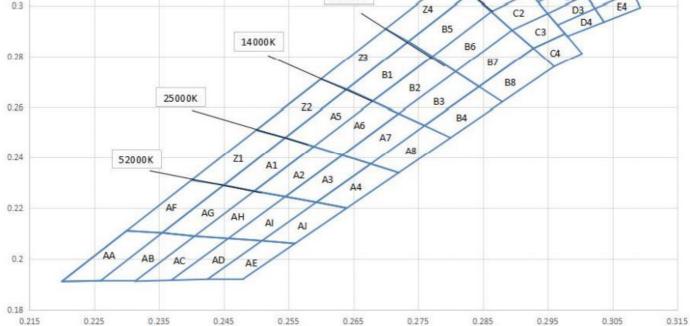
D5 D6 D7

D8 E1

E2

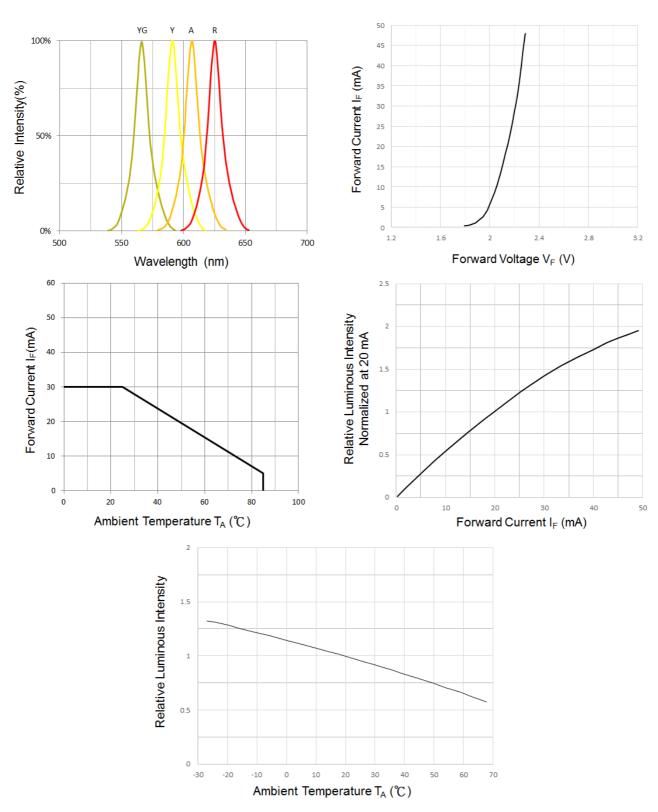
E3





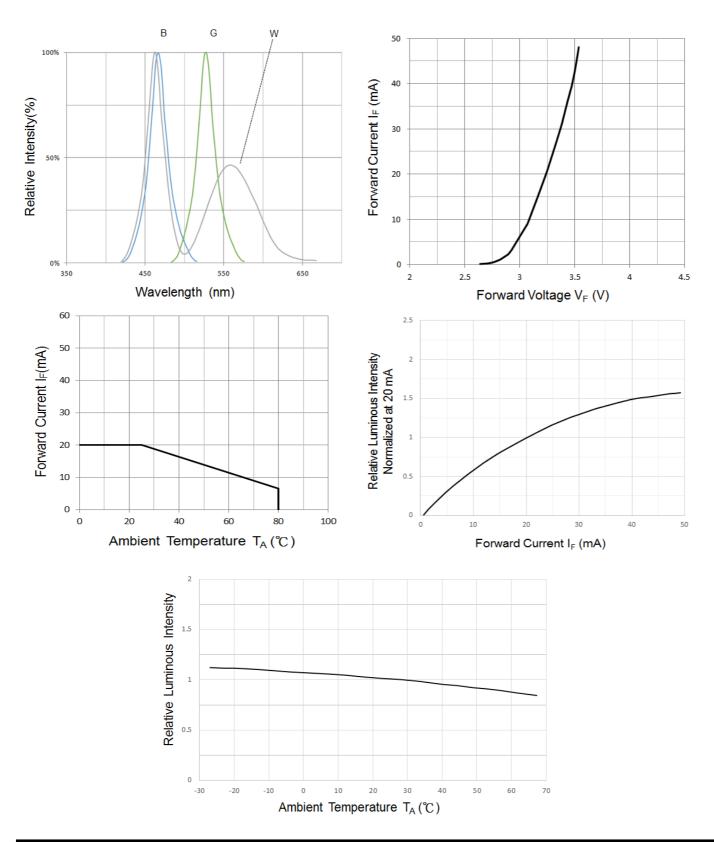






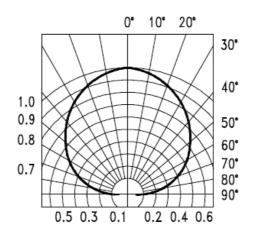








Typical Characteristic Curves – Radiation Pattern

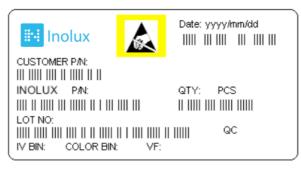


Ordering Information

Product	Emission Color	Technology	Test Current I _F (mA)	Luminous Intensity Iv (mcd) (Typ.)	Forward Voltage V _F (V) (Typ.)	Orderable Part Number
IN-S63AT5YG	-S63AT5YG Yellow Green		5	11.5	2.0	IN-S63AT5YG
IN-S63AT5Y	N-S63AT5Y Yellow		5	35	2.0	IN-S63AT5Y
IN-S63AT5A	Amber	AllnGaP	5	35	2.0	IN-S63AT5A
IN-S63ATR	Red	AllnGaP	20	120	2.2	IN-S63ATR
IN-S63AT5B	Blue	InGaN	5	45	2.8	IN-S63AT5B
IN-S63AT5G	Green	InGaN	5	285	2.7	IN-S63AT5G
IN-S63AT5UW	White	InGaN	5	285	2.8	IN-S63AT5UW



Label Specifications



Inolux P/N:

Ι	Ν	-	S	6	3	А	Т			Х	-	х	Х	x x	(
			Material	Pacl	kage	Variation	Orientation	Current	Lens	Color				nized o-off	
	lux 1D		S = PCB Type	63A :	= 1.6 x (0.8 x 0.4mm	T = Top Mount	(Blank) = 20mA 5=5mA	(Blank) = Clear U = Diffused	R=622nm A=609nm Y=593nm YG=574nm G=530nm B=468nm W=White					

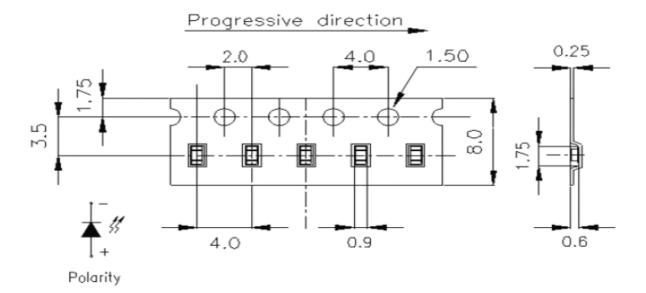
Lot No.:

Z	2	0	1	7	01	24	001
Internal		Year (2017	2018 \	Month	Date	Serial	
Tracker		Tear (2017)	, 2018,)		Month	Date	Senai

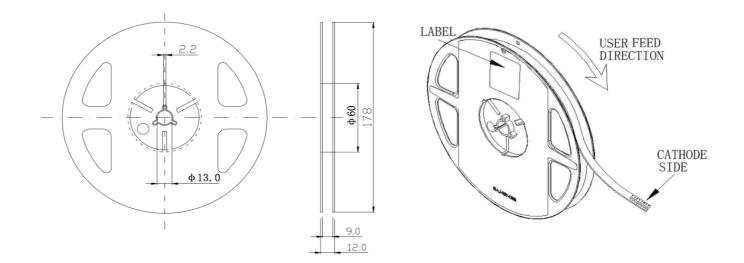


Packaging Information: 4000pcs Per Reel

Tape Dimension

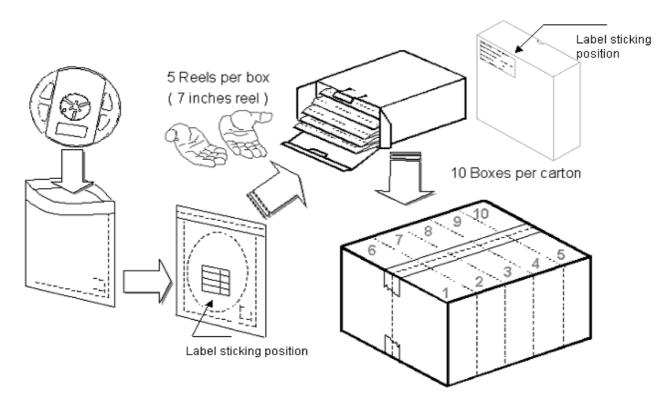


Reel Dimension





Packing Dimension



5 boxes per carton are available depending on shipment quantity.

Specification	Material	Quantity
Per EIA 481-1A specs	Conductive black tape	4000pcs per reel
Per EIA 481-1A specs	Conductive black	· · ·
IN standard	Paper	
220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
IN standard	Paper	Non-specified
	Per EIA 481-1A specs Per EIA 481-1A specs IN standard 220x240mm	Per EIA 481-1A specsConductive black tapePer EIA 481-1A specsConductive blackIN standardPaper220x240mmAluminum laminated bag/ no-zipper

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

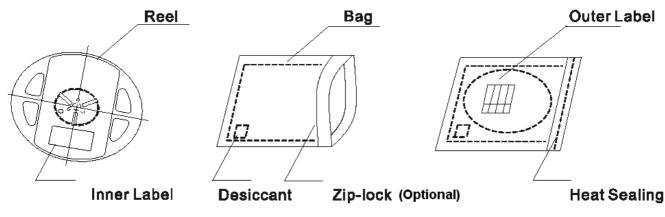


Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

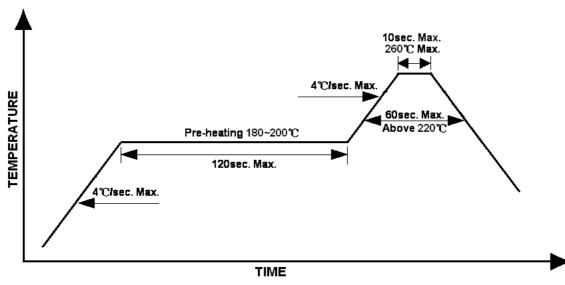
Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



Reflow Soldering

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):



Lead-free Solder Profile



Precautions

- Avoid exposure to moisture at all times during transportation or storage.
- Anti-Static precaution must be taken when handling GaN, InGaN, and AlInGaP products.
- It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- Avoid operation beyond the limits as specified by the absolute maximum ratings.
- Avoid direct contact with the surface through which the LED emits light.
- If possible, assemble the unit in a clean room or dust-free environment.

Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.



Reliability

Item	Frequency/ lots/ samples/ failures	Standards Reference	Conditions
	For all reliability	J-STD-020	1.) Baking at 85°C for 24hrs
Precondition	monitoring tests according	0 010 020	2.) Moisture storage at 85°C/ 60% R.H. for
	to JEDEC Level 2		168hrs
	1Q/1/22/0	JESD22-B102-B	Accelerated aging 155°C/ 24hrs
Solderability		And CNS-5068	Tinning speed: 2.5+0.5cm/s
,			Tinning: A: 215°C/ 3+1s or B: 260°C/ 10+1s
		CNS-5067	Dipping soldering terminal only
Resistance to			Soldering bath temperature
soldering heat			A: 260+/-5°C; 10+/-1s
-			B: 350+/-10°C; 3+/-0.5s
	1Q/ 1/ 40/ 0	CNS-11829	1.) Precondition: 85°C baking for 24hrs
Operating life test			85°C/ 60%R.H. for 168hrs
			2.) Tamb25°C; IF=20mA; duration 1000hrs
High humidity,	1Q/ 1/ 45/ 0	JESD-A101-B	Tamb: 85°C
high temperature			Humidity: 85% R.H., IF=5mA
bias			Duration: 1000hrs
High tomporature	1Q/ 1/ 20	IN specs.	Tamb: 55°C
High temperature bias			IF=20mA
DIAS			Duration: 1000hrs
	1Q/ 1/ 40/ 0		Tamb25°C, If=20mA,, Ip=100mA, Duty
Pulse life test			cycle=0.125 (tp=125 µ s,T=1sec)
			Duration 500hrs)
	1Q/ 1/ 76/ 0	JESD-A104-A	A cycle: -40 degree C 15min; +85 degree C
Tomporatura		IEC 68-2-14, Nb	15min
Temperature			Thermal steady within 5 min
cycle			300 cycles
			2 chamber/ Air-to-air type
High humidity	1Q/ 1/ 40/ 0	CNS-6117	60+3°C
storage test			90+5/-10% R.H. for 500hrs
High temperature	1Q/ 1/ 40/ 0	CNS-554	100+10°C for 500hrs
storage test			
Low temperature	1Q/ 1/ 40/ 0	CNS-6118	-40+5°C for 500hrs
storage test			



Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	02-07-2017
Revise the flux of IN-S63AT5UW	3, 8	1.1	07-10-2017
Revise the drawing	1	1.2	11-28-2017
Update	3,8	1.3	08-20-2019
Updated (new standard)	3,8	1.4	09-01-2021

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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.